u·p·t·o·d·a·t·e Newsletter



January 27, 2016

Product change

Relocation of the CSSP backend production within **Singapore**

In order to serve the increasing demand for EPCOS SAW components, it is necessary to expand the EPCOS production facilities in Singapore. To do so, an additional production facility will be introduced at a nearby location less than 10 kilometers away from the current buildings. The equipment, processes, material and personnel will be transferred from their current location to the new building. Ultimately, the backend production will be fully relocated to the new site.

Front-end wafer production and pre-assembly will remain at current buildings.

Affected products

Ordering code	Туре
B39*B7*	BAW/ SAW components
B39*B8*	BAW/ SAW components
B39*B9*	BAW/ SAW components

The transfer has no effect on product specifications (defined in the data sheet), quality, ordering codes or the delivery times of the affected products. Representative types will be qualified in accordance to EPCOS qualification procedures.

Schedule

March 4, 2016	Availability of samples (representative types) and qualification results
April 1, 2016	Set-up and ready for mass production
April 27, 2016	Scheduled date of introduction and first deliveries from new facility

Enclosure PCN (ID No. M284)

Contact Thomas Friedrich, SAW CEL PM, Munich

Customers are asked to address inquiries directly to their sales contacts.



Product / Process Change Notification

1.	1. ID No.: M284		2. Date of announcement: January 27, 2016	
3.	Product / product group:	Old ordering code:	New ordering code:	Customer part number:
	CSSP devices	B39*B7*	No change	
		B39*B8*		
		B39*B9*		

4. Description of change:

In order to serve the increasing demand for EPCOS SAW components, it is necessary to expand the EPCOS production facilities in Singapore. An additional production facility will be introduced at a nearby location less than 10 km away from the current buildings and the backend production will be ultimately fully relocated to the new site. Equipment, processes, material and personnel will be transferred.

Front-end wafer production and pre-assembly will remain at the current buildings.

5. Effect on the product or for the customer (benefit, quality, specification, lead time):

The transfer has no effect on product specifications (defined in the data sheet), quality, ordering codes or delivery times of the affected products.

6. Quality assurance measures / risk assessment:

Representative types will be qualified in accordance to EPCOS qualification procedures. Samples of representative types and qualification result can be provided on request until March 4, 2016.

7. Scheduled date of change: April 27, 2016

8. Estimated date of first delivery of changed product: April 27, 2016

If EPCOS does not receive notification to the contrary within a period of 10 weeks, EPCOS assumes that the customer agrees to the change. For an interim period we cannot rule out that old as well as new products will be shipped.

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Customer feedback		
Customer acknowledgement	Signature	